Supplier Name:	Texas Instruments Inc. (DUNS# 00-732-1904)
Contact Info:	ti.com/support
Form/Declaration Type:	Distribute - RoHS and IEC 62474 DB
Created on:	06/10/2022

Details for "TPS3898ADRYT"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
TPS3898ADRYT	NIPDAU	Level-1-260C-UNLIM	Ext-Mfg	DRY 6	1.5x1x0.55	2.9

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Precious Metals	Gold	7440-57-5	0.0172	100	1000000	0.600611	6006
Sub-Total			0.0172	100	1000000	0.600611	6006
Die Attach Adhesive	-						
Other Inorganic Materials	Aluminum Oxide	1344-28-1	0.012593	30.000476	300005	0.439738	4397
Other Inorganic Materials	Silica	7631-86-9	0.001889	4.500191	45002	0.065962	660
Other Organic Materials	Chlorine	7782-50-5	0.000015	0.035735	357	0.000524	5
Thermoplastics	Ероху	85954-11-6	0.027479	65.463598	654636	0.959546	9595
Sub-Total			0.041976	100	1000000	1.46577	14658
Lead Frame	•	•					-
Copper and Its Alloys	Copper	7440-50-8	1.50936	99.3	993000	52.705718	527057
Other Nonferrous Metals and Alloys	Chromium	7440-47-3	0.0038	0.25	2500	0.132693	1327
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.0038	0.25	2500	0.132693	1327
Zinc and Its Alloys	Zinc	7440-66-6	0.00304	0.2	2000	0.106155	1062
Sub-Total			1.52	100	1000000	53.077259	530773
Lead Frame Plating	•	•					
Nickel and Its Alloys	Nickel	7440-02-0	0.019024	95.12	951200	0.664304	6643
Precious Metals	Gold	7440-57-5	0.000156	0.78	7800	0.005447	54
Precious Metals	Palladium	7440-05-3	0.00082	4.1	41000	0.028634	286
Sub-Total			0.02	100	1000000	0.698385	6984
Mold Compound	-	-					
Other Inorganic Materials	Fused Silica	60676-86-0	0.893449	90.00001	900000	31.198568	311986
Other Organic Materials	Proprietary Non Halide Flame Retardant	Trade Secret	0.029782	3.000037	30000	1.039965	10400
Other Plastics and Rubber	Carbon Black	1333-86-4	0.001985	0.199955	2000	0.069315	693
Thermoplastics	Ероху	85954-11-6	0.067505	6.799997	68000	2.357224	23572
Sub-Total			0.992721	100	1000000	34.665072	346651
Semiconductor Device	•	•					
Ceramics / Glass	Doped Silicon	7440-21-3	0.271853	100	1000000	9.492903	94929
Sub-Total			0.271853	100	1000000	9.492903	94929
Total			2.86375			100	1000000

Important Note

The ppm calculations are at the **homogeneous material** level and are maximum concentration values. The ppm displayed represents the **homogeneous material** with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component. The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**.

See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is." For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/10/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.